

EEE-2103: Electronic Devices and Circuits

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pn-Junction Diode

Diode →

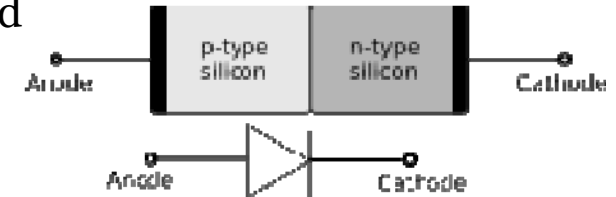
pn-junction + connecting leads

one-way device = low resistance when forward biased

open switch when reverse biased

constant forward voltage drop

constant reverse saturation current

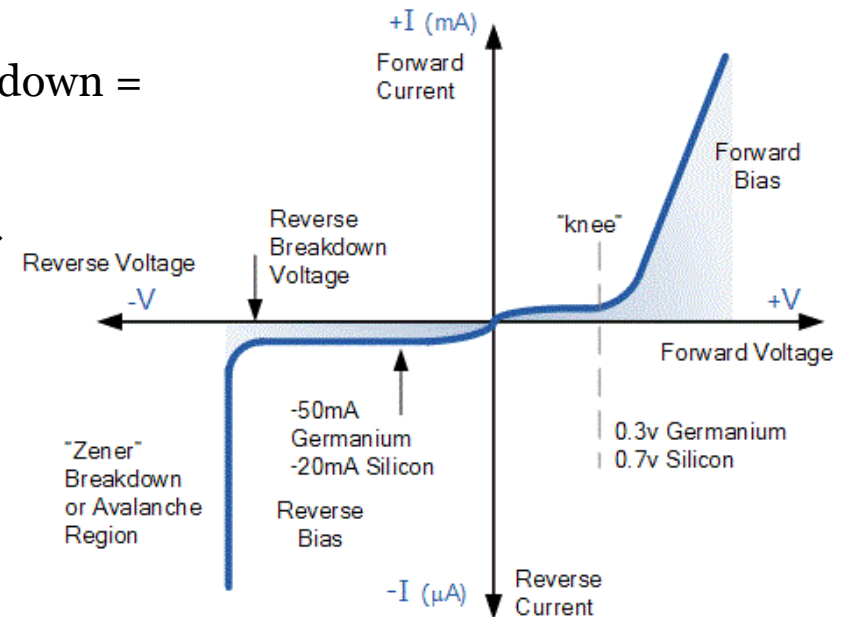


Diode is destroyed if →

high forward current overheats device

large reverse voltage causes junction to break down =
reverse breakdown

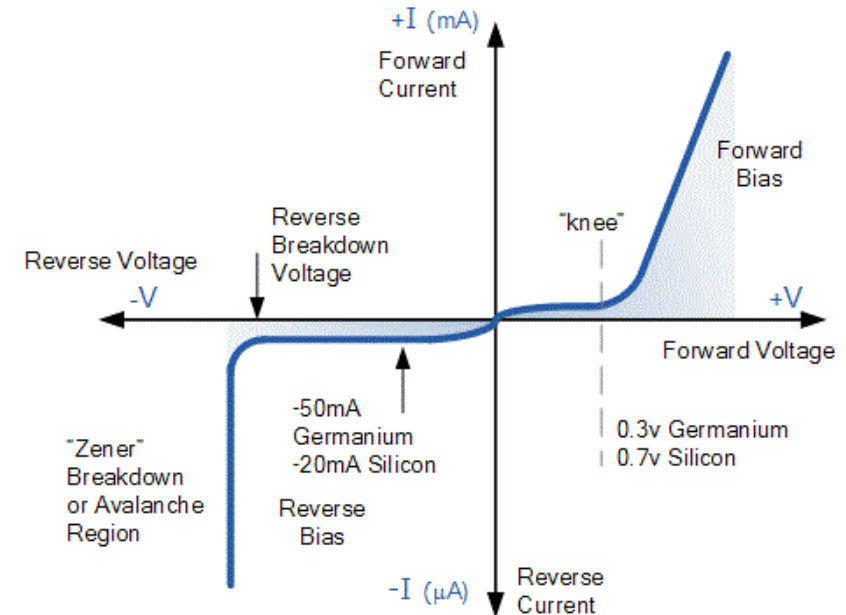
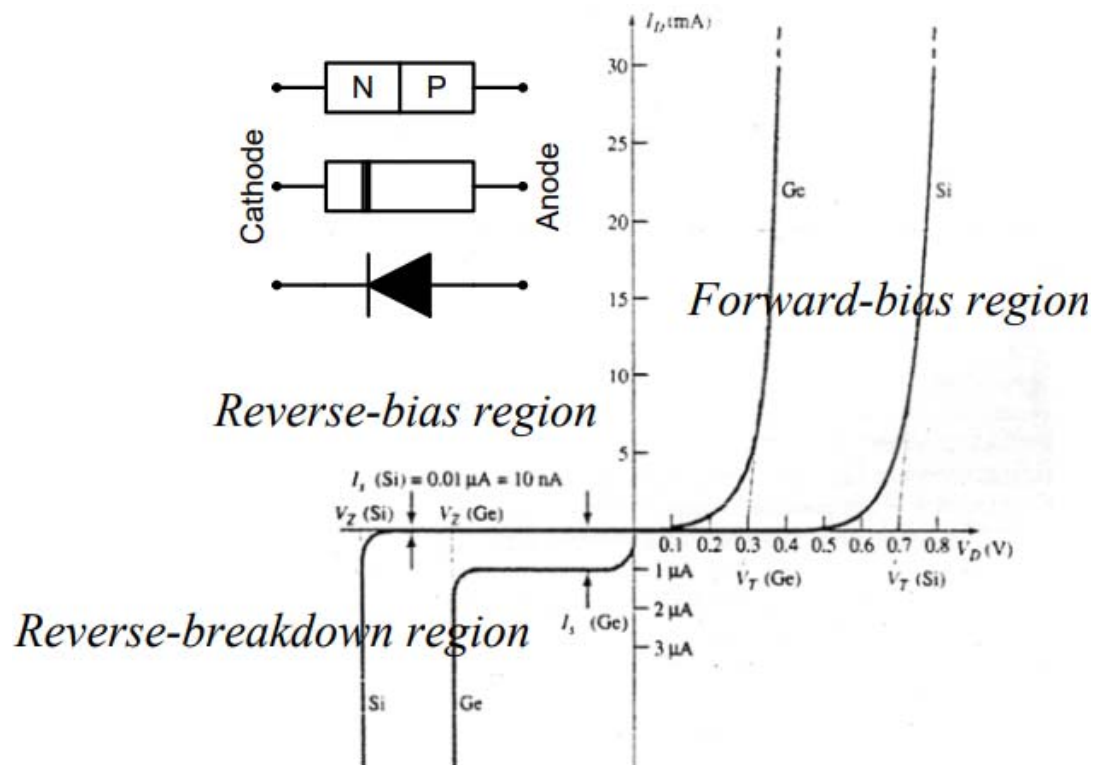
Typical forward and reverse characteristics of diode →



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Ge diode → lower forward voltage drop

Si diode → lower reverse current
higher reverse breakdown voltage



Reverse Breakdown Voltage
-50mA Germanium
-20mA Silicon
Reverse Bias
"knee"
Forward Voltage
0.3v Germanium
0.7v Silicon

***pn*-Junction Diode**

Ideal diode:

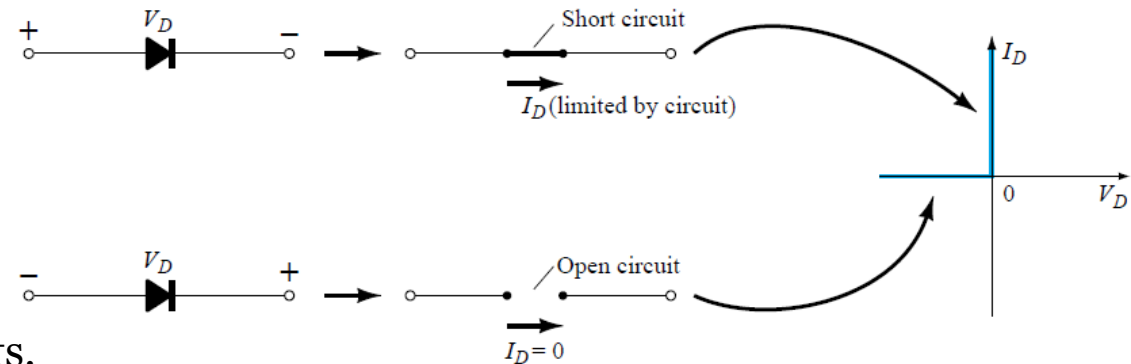
Short circuit in forward bias

Open circuit in reverse bias

DC equivalent circuits:

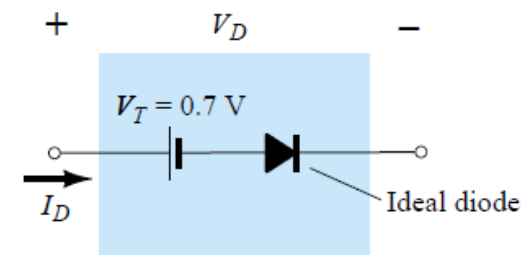
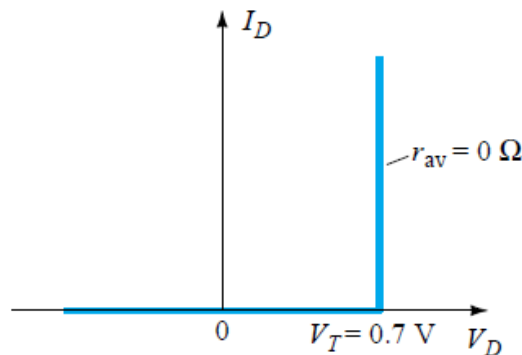
Represents device behavior

Made up of number of basic components.



Diode equivalent circuits are necessary →
substituted for device when investigating circuit
used as device models for computer analysis.

Simplified equivalent circuit:

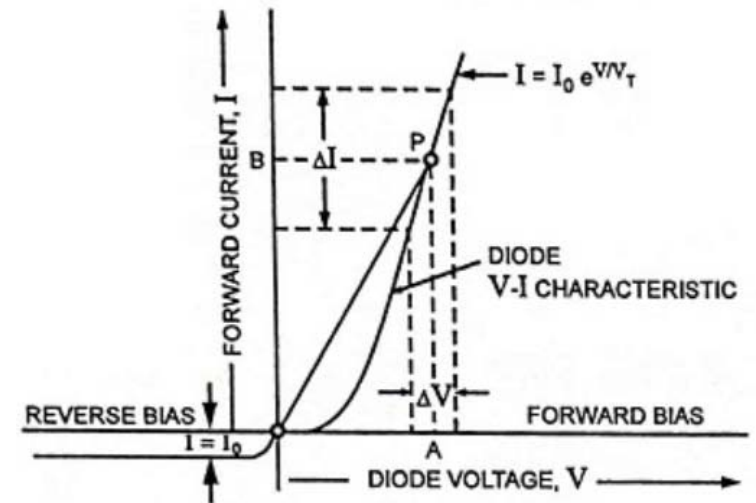
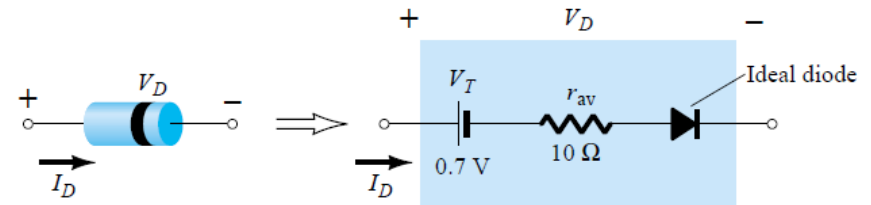


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Piecewise-linear equivalent circuits:

$r_d = r_{av}$ = dynamic/ac resistance
 = offered to changing levels of forward voltage
 $= \Delta V_F / \Delta I_F$
 $= 26 \text{ mV} / I_F + \text{dc resistance of semiconductor material}$
 $\approx 26 \text{ mV} / I_F + 2 \Omega$

V_T = knee voltage
 $= 0.7 \text{ V for Si, } 0.3 \text{ V for Ge}$



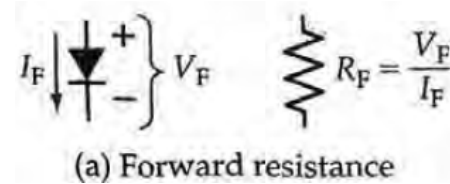
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Problem-3:

Calculate the forward and reverse resistances offered by a silicon diode, with forward voltage of 0.75 V and reverse saturation current of 100 nA, at $I_F = 100$ mA and at $V_R = 50$ V.

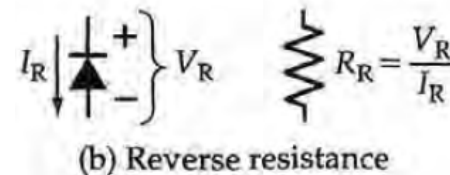
At $I_F = 100$ mA, $V_F = 0.75$ V

$$R_F = V_F / I_F = 0.75 / 100 \times 10^{-3} = 7.5 \, \Omega$$



At $V_R = 50$ V, $I_R = 100$ nA

$$R_R = V_R / I_R = 50 / 100 \times 10^{-9} = 500 \, \text{M}\Omega$$



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Problem-4:

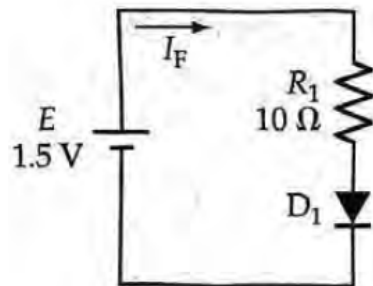
Calculate I_F for the diode circuit in Fig. (a) assuming that the diode has $V_F = 0.7$ V and $r_d = 0$. Then recalculate the current taking $r_d = 0.25$ Ω .

Substituting V_F as the diode equivalent circuit

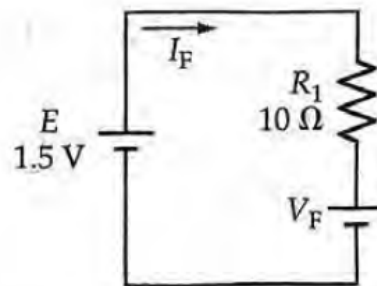
$$I_F = (E - V_F)/R_1 = (1.5 - 0.7)/10 = 80 \text{ mA}$$

Substituting V_F and r_d as the diode equivalent circuit

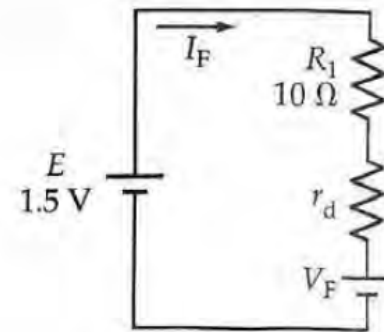
$$I_F = (E - V_F)/(R_1 + r_d) = (1.5 - 0.7)/(10 + 0.25) = 78 \text{ mA}$$



(a) Diode circuit



(b) Diode replaced with voltage cell



(c) Diode replaced with r_d and V_F

Zener Diodes

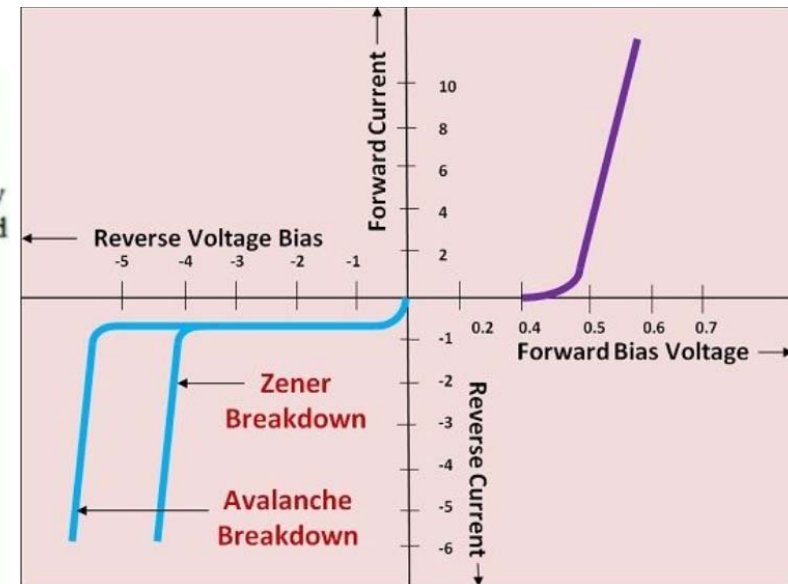
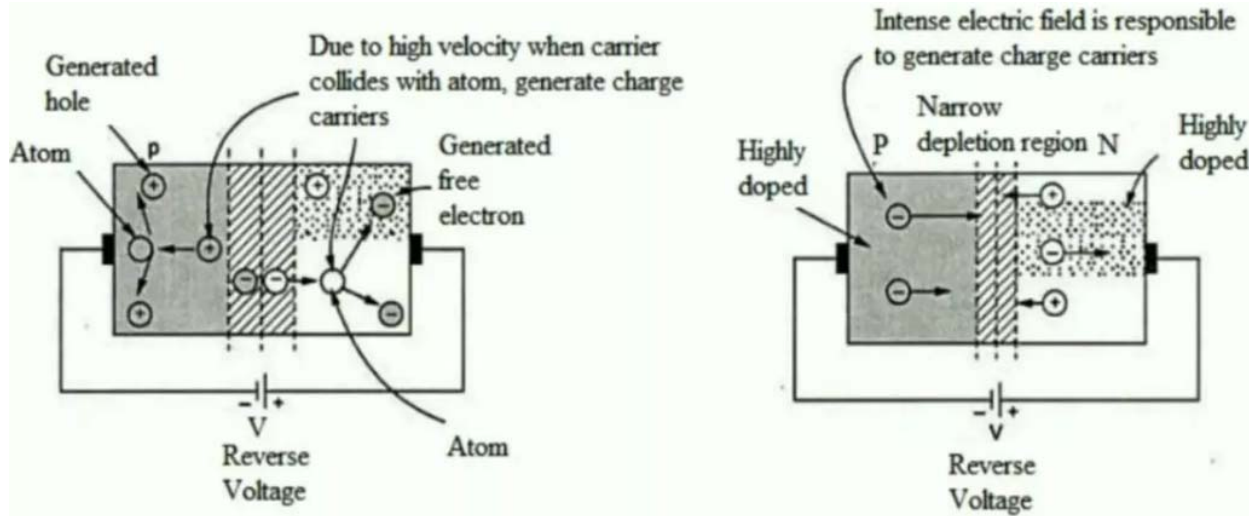
V_Z = Zener potential →

reverse-bias potential that results dramatic change in characteristics
current increases at very rapid rate
current direction is opposite to that of positive voltage region

Breakdown → Avalanche and Zener

Zener region → sharp change in characteristic at any level

Zener diode → *pn*-junction diodes employing this unique portion of characteristic



Zener Diodes

Location of Zener region can be controlled by varying doping levels.

Increase in doping \rightarrow increase in number of added impurities \rightarrow decrease Zener potential.

Zener potentials = $V_Z \rightarrow 1.8$ to 200 V

Dynamic resistance = $r_z \rightarrow 8.5 \Omega$

Power ratings $\rightarrow \frac{1}{4}$ to 50 W.

Silicon is preferred \rightarrow higher temperature and current capability.

Zener equivalent circuits \rightarrow

